



(0.635 mm) .025"

QFS-RA SERIES

RIGHT-ANGLE GROUND PLANE SOCK

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QFS-RA

Insulator Material:

Liquid Crystal Polymer Terminal & Ground Plane Material:

Phosphor Bronze

Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail)

Voltage Rating: 300 VAC

Operating Temp: -55 °C to +125 °C RoHS Compliant:

PROCESSING

Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0.10 mm) .004" max (026-052) (0.15 mm) .006" max (078)* *(.004" stencil solution may be available; contact IPG@samtec.com)

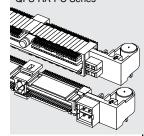
RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



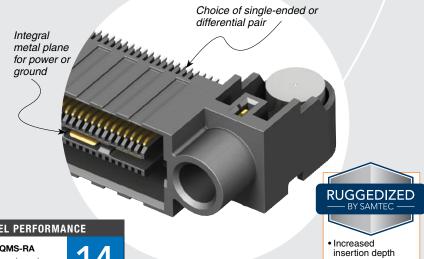
OTHER **SOLUTIONS**

Combination Signal/Power See QMS-RA-PC Series or QFS-RA-PC Series



Some lengths, styles and options are non-standard, non-returnable.

Board Mates:



HIGH-SPEED CHANNEL PERFORMANCE

QFS-RA/QMS or QFS-RA/QMS-RA

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

Integral guide post

PCB mounting pins

PLATING PINS PER ROW OTHER QFS OPTION OPTION NO. OF PAIRS

-026, -052, -078(52 total pins per bank = -D)

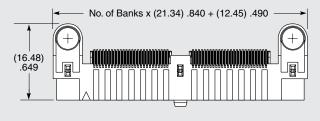
–016, *–*032, *–*048 (16 pairs per bank = -D-DP)

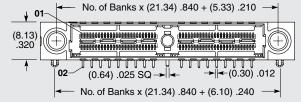
SL = 10 µ" (0.25 µm) Gold on Signal Pins and Ground Plane, Matte Tin on tails

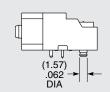
-D = Single-Ended -D-DP = Differential Pair

–K = Polyimide film Pick & Place Pad

–TR = Tape & Reel (-016, -026, -032 & -052 positions only)







ALSO AVAILABLE (MOQ Required)

- Other platings
- Plastic Guide Post option
- -02 lead style for (2.36 mm) .093" thick board
- 64 (-DP) and 104 positions per row Contact Samtec.

Due to technical progress, all designs, specifications and components are subject to change without notice